

650V 4A Field Stop Trench IGBT

V _{CES}	650V
I _{C(100°C)}	4A
V _{CE(sat) (Typ.)}	1.65V
P_{D}	62W

Features

- 1) Low Collector Emitter Saturation Voltage
- 2) Low Switching Loss
- 3) Short Circuit Withstand Time 5µs
- 4) Built in Very Fast & Soft Recovery FRD (RFN Series)
- 5) Pb free Lead Plating; RoHS Compliant

Applications

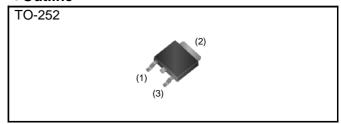
General Inverter

UPS

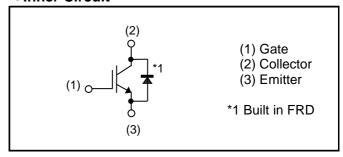
Power Conditioner

Welder

Outline



●Inner Circuit



Packaging Specifications

	Packaging	Taping
Reel Size	Reel Size (mm)	330
Type	Tape Width (mm)	16
Туре	Basic Ordering Unit (pcs)	2,500
	Taping Code	TL
	Marking	RGT8BM65D

◆Absolute Maximum Ratings (at T_C = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit
Collector - Emitter Voltage		V_{CES}	650	V
Gate - Emitter Voltage		V_{GES}	±30	V
Collector Current	T _C = 25°C	I _C	8	A
Collector Current	T _C = 100°C	I _C	4	А
Pulsed Collector Current		I _{CP} *1	12	A
Diode Forward Current	T _C = 25°C	I _F	7	А
	T _C = 100°C	I _F	4	А
Diode Pulsed Forward Current		I _{FP} *1	12	А
Power Dissipation	T _C = 25°C	P _D	62	W
	T _C = 100°C	P _D	31	W
Operating Junction Temperature		T _j	-40 to +175	°C
Storage Temperature		T _{stg}	-55 to +175	°C

^{*1} Pulse width limited by $T_{jmax.}$

●Thermal Resistance

Parameter	Symbol	Values			Unit
		Min.	Тур.	Max.	Offic
Thermal Resistance IGBT Junction - Case	$R_{\theta(j-c)}$	-	-	2.40	°C/W
Thermal Resistance Diode Junction - Case	$R_{\theta(j-c)}$	-	-	9.20	°C/W

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
r ai ai nietei	Symbol	Conditions	Min.	Тур.	Max.	Offic
Collector - Emitter Breakdown Voltage	BV _{CES}	$I_C = 10 \mu A, V_{GE} = 0 V$	650	-	-	V
Collector Cut - off Current	I _{CES}	$V_{CE} = 650V, V_{GE} = 0V$	1	-	10	μΑ
Gate - Emitter Leakage Current	I _{GES}	$V_{GE} = \pm 30V, V_{CE} = 0V$	•	-	±200	nA
Gate - Emitter Threshold Voltage	$V_{GE(th)}$	$V_{CE} = 5V, I_{C} = 2.8 \text{mA}$	5.0	6.0	7.0	V
Collector - Emitter Saturation Voltage	V _{CE(sat)}	$I_C = 4A$, $V_{GE} = 15V$ $T_j = 25$ °C $T_j = 175$ °C	-	1.65 2.1	2.1 -	V

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions		Unit		
Parameter 	Symbol	Conditions	Min.	Тур.	Max.	Offic
Input Capacitance	C _{ies}	V _{CE} = 30V	-	220	-	
Output Capacitance	C _{oes}	$V_{GE} = 0V$	-	14	-	pF
Reverse Transfer Capacitance	C _{res}	f = 1MHz	-	4.5	-	
Total Gate Charge	Q_g	V _{CE} = 400V	-	13.5	-	
Gate - Emitter Charge	Q_ge	$I_C = 4A$	-	4	-	nC
Gate - Collector Charge	Q_{gc}	V _{GE} = 15V	-	5.5	-	
Turn - on Delay Time	t _{d(on)}	$I_C = 4A, V_{CC} = 400V$	-	17	-	
Rise Time	t _r	$V_{GE} = 15V, R_G = 50\Omega$	-	36	-	
Turn - off Delay Time	t _{d(off)}	T _j = 25°C	-	69	-	ns
Fall Time	t _f	Inductive Load	-	71	-	
Turn - on Delay Time	t _{d(on)}	$I_C = 4A, V_{CC} = 400V$	-	17	-	
Rise Time	t _r	$V_{GE} = 15V, R_{G} = 50\Omega$	-	37	-	20
Turn - off Delay Time	$t_{d(off)}$	T _j = 175°C	-	86	-	ns
Fall Time	t _f	Inductive Load	-	72	-	
		$I_C = 12A, V_{CC} = 520V$				
Reverse Bias Safe Operating Area	RBSOA	$V_P = 650V, V_{GE} = 15V$	FU	LL SQUA	RE	-
		$R_G = 50\Omega, T_j = 175^{\circ}C$				
		$V_{CC} \le 360V$				
Short Circuit Withstand Time	t _{sc}	V _{GE} = 15V	5	-	-	μs
		T _j = 25°C				

•FRD Electrical Characteristics (at $T_j = 25$ °C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Linit
			Min.	Тур.	Max.	Unit
Diode Forward Voltage	V _F	$I_F = 4A$ $T_j = 25$ °C $T_j = 175$ °C	-	1.45 1.4	1.9	V
Diode Reverse Recovery Time	t _{rr}	I _F = 4A	-	40	ı	ns
Diode Peak Reverse Recovery Current	I _{rr}	$V_{CC} = 400V$ $di_F/dt = 200A/\mu s$	-	4.3	1	А
Diode Reverse Recovery Charge	Q_{rr}	T _j = 25°C	-	0.09	1	μC
Diode Reverse Recovery Time	t _{rr}	I _F = 4A	-	94	ı	ns
Diode Peak Reverse Recovery Current	I _{rr}	$V_{CC} = 400V$ $di_F/dt = 200A/\mu s$	-	5.4	1	А
Diode Reverse Recovery Charge	Q_{rr}	T _j = 175°C	-	0.27	-	μC

• Electrical Characteristic Curves

Fig.1 Power Dissipation vs. Case Temperature

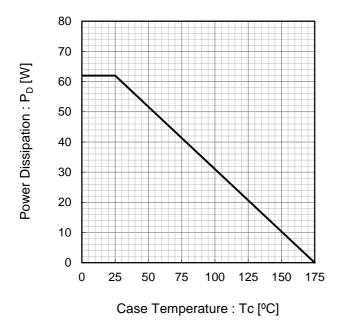


Fig.2 Collector Current vs. Case Temperature

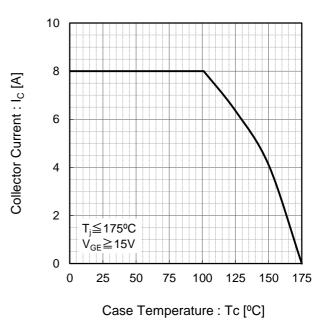


Fig.3 Forward Bias Safe Operating Area

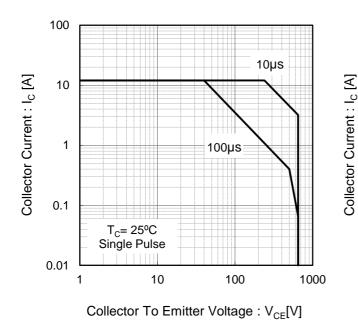
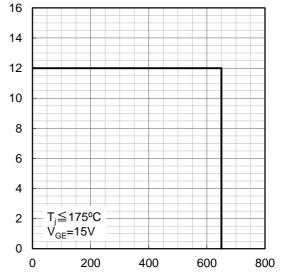


Fig.4 Reverse Bias Safe Operating Area



•Electrical Characteristic Curves

Fig.5 Typical Output Characteristics

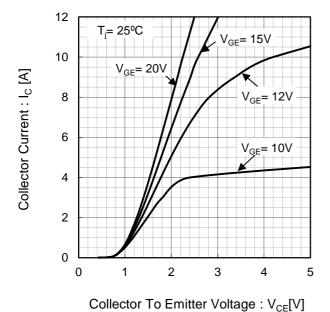
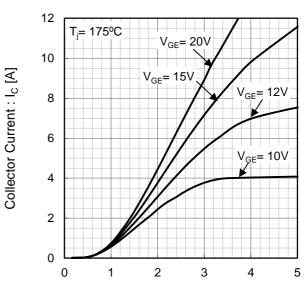


Fig.6 Typical Output Characteristics



Collector To Emitter Voltage : V_{CE}[V]

Fig.7 Typical Transfer Characteristics

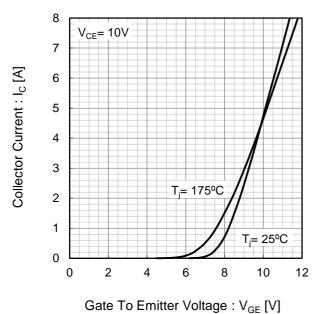
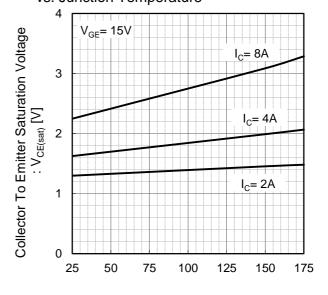


Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature



Junction Temperature : T_i [°C]

• Electrical Characteristic Curves

Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage

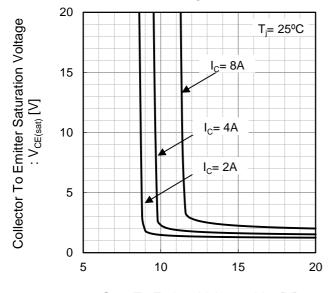
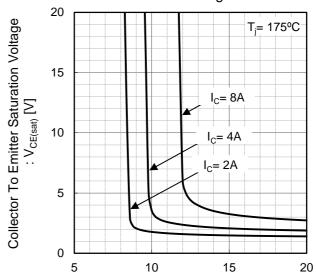


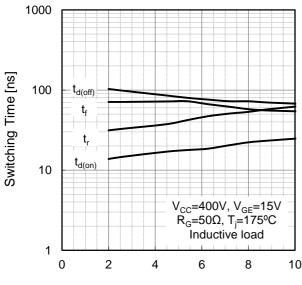
Fig.10 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage



Gate To Emitter Voltage : V_{GE} [V]

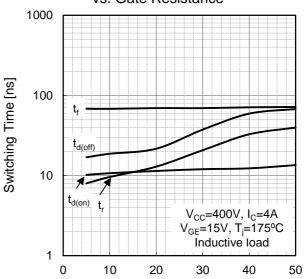
Gate To Emitter Voltage : V_{GE} [V]

Fig.11 Typical Switching Time vs. Collector Current



Collector Current : I_C [A]

Fig.12 Typical Switching Time vs. Gate Resistance



Gate Resistance : $R_G[\Omega]$

•Electrical Characteristic Curves

Fig.13 Typical Switching Energy Losses vs. Collector Current 10 Switching Energy Losses [mJ] 1 0.1 V_{CC} =400V, V_{GE} =15V R_{G} =50 Ω , T_{j} =175°C E_{off} Inductive load 0.01 0 2 4 6 10 Collector Current : I_C [A]

vs. Gate Resistance

10

Segon 1

Eoff Vcc=400V, Ic=4A

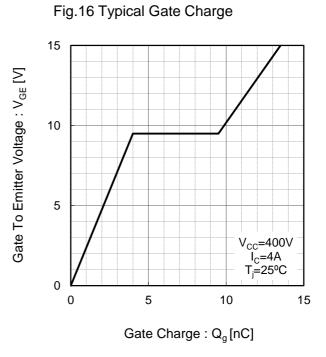
V_GE=15V, $T_j=175^{\circ}C$ Inductive load

0.01

Gate Resistance : $R_G[\Omega]$

Fig.14 Typical Switching Energy Losses

Fig.15 Typical Capacitance vs. Collector To Emitter Voltage 10000 1000 Capacitance [pF] Cies 100 Coes 10 f=1MHz Cres $V_{GE}=0V$ 0.01 0.1 1 10 100 Collector To Emitter Voltage : V_{CE}[V]





• Electrical Characteristic Curves

Fig.17 Typical Diode Forward Current vs. Forward Voltage 12 10 Forward Current: I_F [A] 8 6 4 T_i= 175°C 2 T_i= 25°C 0 1.5 2 2.5 3 0.5

vs. Forward Current 120 Reverse Recovery Time: t_{rr} [ns] 100 80 T_i= 175°C 60 40 $T_{i} = 25^{\circ}C$ V_{CC} =400V di_F/dt=200A/µs 20 Inductive load 0 2 4 6 8 10 Forward Current : I_F [A]

Fig.18 Typical Diode Reverse Recovery Time

Fig.19 Typical Diode Reverse Recovery Current vs. Forward Current

Forward Voltage : V_F[V]

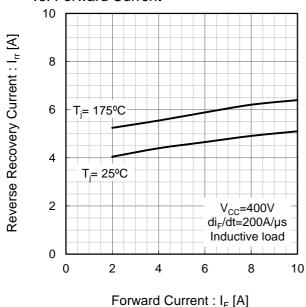
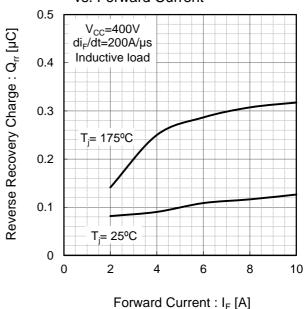


Fig.20 Typical Diode Reverse Recovery Charge vs. Forward Current



•Electrical Characteristic Curves

Fig.21 IGBT Transient Thermal Impedance

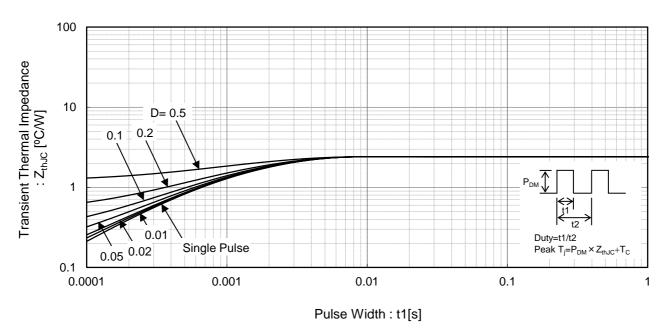
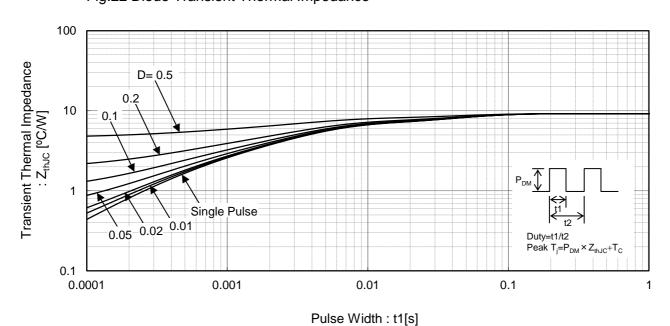


Fig.22 Diode Transient Thermal Impedance





●Inductive Load Switching Circuit and Waveform

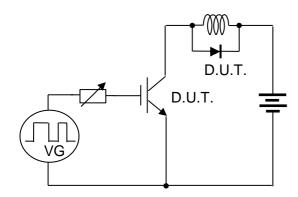


Fig.23 Inductive Load Circuit

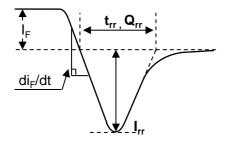


Fig.25 Diode Reverce Recovery Waveform

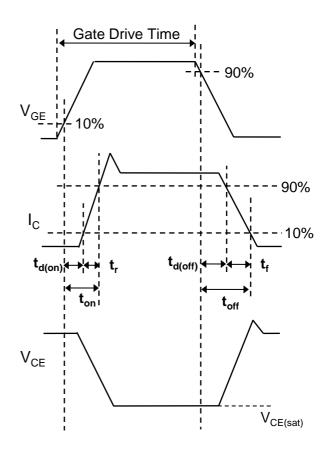


Fig.24 Inductive Load Waveform

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